

Contents

CHAPTER 1

Introduction		
1.1	Advanced materials for space applications	1
	(1) Classification of Thermal Protection Systems	2
	(2) Composite materials as TPS	3
1.2	Advantages of advanced materials in space applications	4
1.3	Composites	5
1.4	Ceramic matrix composites (CMCs)	6
	(1) Reinforcement in CMCs	7
	(2) Carbon fibres	9
	(3) Carbon fibres derived from PAN	10
	(4) Fibre architecture	11
1.5	Fibre-matrix interfaces in CMCs	12
	(1) Types of interphases	13
	(A) PyC interface coating	14
	(B) BN interface coating	14
1.6	Ceramic matrix	15
	(1) Hot pressing	16
	(2) Sintering	16
	(3) Reaction sintering	16
	(4) Gas deposition method	17
1.7	Processing of ceramic matrix composites	17
	(1) Polymer infiltration pyrolysis (PIP) process	18
	(2) Reactive melt infiltration (RMI) process	18
	(3) Chemical vapour infiltration (CVI) process	19
1.8	Space applications of CMCs	20
1.9	Fundamentals of joining	21
	(1) Wettability	22
	(2) Spreading and adhesion	24
	(3) Pore infiltration	24
	(4) Extent of reaction	25
	(5) Residual stresses	25
1.10	Joining methods	26
	(1) Mechanical Joining	27
	(2) Adhesive Joining	28
	(3) Diffusion Bonding	29
	(4) Brazing	30
	(5) Transient liquid phase diffusion bonding	31
1.11	Conclusions	32
1.12	Objectives of the thesis	32
1.13	Organisation of the Thesis	33

CHAPTER 2

Literature Survey		41
2.1	Introduction	41
2.2	Joining of C/SiC composites	42
	(1) Direct bonding	42

(2)	Indirect Bonding	42
(A)	Silicon (Si) based joining of C/SiC composites	43
(B)	Silver (Ag) based joining of C/SiC composites	44
(C)	Nickel (Ni) based joining of C/SiC composites	44
(D)	Molybdenum (Mo) based joining of C/SiC composites	45
(E)	MAX-based joining of C/SiC composites	46
(F)	High-temperature fillers-based joining of C/SiC composites	50
2.3	Joining of C/SiC composites to metals	52
(1)	Diffusion bonding	53
(2)	Brazing with low-temperature fillers	54
(3)	Brazing with high-temperature fillers	57
2.4	Joining of monolith SiC ceramics	60
(1)	Preceramic polymer-based joining	60
(2)	No interlayer	60
(3)	Diffusion bonding	62
(4)	Brazing	63
(A)	Ti-based brazing of SiC ceramics	64
(B)	Ti-free brazing of SiC ceramics	66
(C)	Metal-ceramic hybrid materials	67
(5)	MAX phase joining	70
2.5	Conclusions	71

CHAPTER 3

	Design of the joint	81
3.1	Introduction	81
3.2	Types of joints	82
(1)	Butt joint	82
(2)	Lap joint	83
(3)	Butt-lap joint	85
(4)	Scarf Joints	85
3.3	Design changes for enhancing joint strength	85
3.4	Design of filler material	86
3.5	Management of residual stresses in a joint	88
3.6	Crack generation in a joint	89
3.7	Available forms of brazing filler material	90
3.8	Passive and active brazing	90
3.9	Selection of brazing method	91
(1)	Torch/flash brazing	91
(2)	Furnace brazing	91
(3)	Induction brazing	92
(4)	Vacuum brazing	92
(5)	Dip brazing	93
(6)	Infrared brazing	93
3.10	Conclusions	94

CHAPTER 4

	Joining of C/SiC composite to C103 alloy	97
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4.1	Introduction	97
4.2	Experimental	100
	4.2.1 Fabrication of joints	100
	4.2.2 Microstructural characterisation	103
	4.2.3 Evaluation of LSS	103
	4.2.4 Response Surface Methodology	104
	4.2.5 Objective function	106
4.3	Results and Discussion	106
	4.3.1 Joint microstructures and composition	106
	4.3.2 Fracture surface analysis	111
	4.3.3 Microstructure evolution mechanism	116
	4.3.4 RSM analysis and process optimisation	116
4.4	Conclusions	121
 CHAPTER 5		
	Joining of C/SiC composites	127
5.1	Introduction	127
5.2	Experimental	130
5.3	Results and Discussion	133
	5.3.1 Brazing Formulations Analysis	133
	5.3.2 Microstructure of the joint interface	136
	5.3.3 Mechanical analysis	141
	5.3.4 Joining mechanism	143
5.4	Conclusions	146
 CHAPTER 6		
	Joining of monolith SiC ceramic	153
6.1	Introduction	153
6.2	Experimental	156
6.3	Results and Discussion	158
	6.3.1 Brazing Filler Characterisation	158
	6.3.2 Microstructural characterisation of joints	159
	6.3.3 Mechanical performance of joints	169
	6.3.4 Joining mechanism	172
6.4	Conclusions	178
 CHAPTER 7		
7.1	Conclusions	185
	(1) Joining of C/SiC to C103 alloy	185
	(2) Joining of C/SiC composites	186
	(3) Joining of monolith SiC ceramics	186
7.2	Future prospects	187
 APPENDIX		188

List of Figures

Fig. No.	Figure	Page No.
Chapter 1		
1.1	TSTO working concept concerning Mach number and altitude.....	2
1.2	Historical development of TPS.....	3
1.3	Specific strength vs service temperature for advanced materials.....	4
1.4	Classification of composites based on reinforcement, interphase, and matrix	6
1.5	Design of CMCs.....	6
1.6	Classification of fibres.....	8
1.7	Turbostratic structure of carbon fibre.....	9
1.8	Chemical structure of PAN.....	9
1.9	PAN to carbon fibre production process.....	10
1.10	(a) 1D, (b) 2D, (c) 3D, and (d) 2.5D preforms	12
1.11	Stress flow diagram for strong vs weak interface.....	13
1.12	CVI Infiltration mechanism.....	19
1.13	Schematic for CVI process.....	20
1.14	Potential applications of joining of ceramics: (a) C/SiC body flaps, (b) C/SiC mirror, (c) C/SiC plate stacks for heat exchanger, and (d) C/SiC thrust chamber.....	21
1.15	Thermodynamic balance amongst the various interfacial energies.....	23
1.16	Types of joining of CMCs.....	27
Chapter 2		
2.1	Schematic of (a) direct, and (b) indirect bonding.....	42
2.2	Elements that react to produce MAX phases.....	47
2.3	Schematic of SPS bonding setup.....	48
2.4	(a) Phase distribution and (b) phase map of interface by EBSD.....	49
2.5	3D image of the fractured surface.....	50
2.6	SEM micrographs of the joint interface.....	55
2.7	Reaction duration influence on the thickness of TiC layer (a) 2, (b) 5, (c) 10, and (d) 25 min.....	56
2.8	(a) Formation of nail in C/SiC and (b) fracture path in joint.....	57
2.9	Diffusion bonding and testing setup for SiC-SiC joints.....	63
2.10	(a) SEM image and (b) XRD pattern (a) Ni-Si (b) Ni-Si-2 wt.% Ti, (c) Ni-Si-5 wt.% Ti, and (d) Ni-Si-10 wt.% Ti of the joint interface.....	65
2.11	Sketch of UA brazing process.....	66
2.12	Interfacial microstructure evolution model: (a) accumulation of Ti particles around B ₄ C and SiC, (b) reaction to form new phases, (c) reaction layer growth, and (d) formation of joint by solidification.....	69
2.13	(a) Microwave applicator setup and (b) expanded view of job.....	69
Chapter 3		
3.1	Types of joints.....	83
3.2	Various joint configurations of evaluation of shear strength.....	84
3.3	Changes in the design to reduce the concentration of stresses.....	86
3.4	Classification of filler alloy systems.....	88
3.5	(a) Edge crack and (b) core crack in ceramics.....	89

3.6	Various forms of brazing filler material.....	90
3.7	(a) Torch/flash and (b) induction brazing.....	91
3.8	Vacuum brazing facility.....	92
3.9	Dip brazing process.....	93

Chapter 4

4.1	Chemical vapour infiltration (CVI) reactor in VSSC/ISRO.....	101
4.2	Optical image of a) C/SiC, b) Ticusil-based and c) Cusil-based C/SiC-C103 joint.....	101
4.3	SEM micrographs of (a) C/SiC composite and (b) C103 alloy.....	101
4.4	DSC curves of Ticusil and Cusil braze alloys.....	102
4.5	Vacuum brazing furnace.....	102
4.6	(a) C/SiC-C103 test specimen configuration and (b) LSS test set-up.....	104
4.7	(a) SEM image, (b) line scan, and (c) elemental mapping of the cross-section of Ticusil-based joint.....	107
4.8	XRD patterns of substrates and C/SiC-C103 joints.....	108
4.9	(a) SEM image, (b) line scan, and (c) elemental mapping of the cross-section of Cusil-based joint.....	110
4.10	(a) SEM image and (b) elemental mapping of fracture surface of Ticusil-based joint.....	112
4.11	(a) SEM image and (b) elemental mapping of fracture surface of Cusil-based joint.....	113
4.12	Optical profilometer image of the fracture surface of (a) Ticusil and (b) Cusil-based joints.....	113
4.13	Load-displacement graph of C/SiC-C103 joint.....	114
4.14	Microstructure evolution mechanism: (a) before joining, (b) during the brazing process, (c) after brazing for Ticusil-based joint, (d) after brazing for Cusil-based joint, (e) during LSS test for Ticusil-based joint, and (f) during LSS test for Cusil-based joint.....	115
4.15	Desirability for (a) and (b) Ticusil-based joint, and (c) Cusil-based joint.....	119

Chapter 5

5.1	Schematic for the processing of braze joints.....	131
5.2	DSC curves of brazing material formulations.....	134
5.3	Ni-Si phase diagram indicating the theoretical melting points for various brazing filler compositions.....	134
5.4	Contact angle of (a) CNT-0, (b) CNT-5, (c) CNT-10, and (d) CNT-15 droplets on C/SiC substrate.....	135
5.5	SEM image and line scan of (a)-(b) J-CNT-0, (c)-(d) J-CNT-5, (e)-(f) J-CNT-10, and (g)-(h) J-CNT-15 joint interfaces.....	137
5.6	High magnification SEM images of (a) J-CNT-0, (b) J-CNT-5, (c) J-CNT-10, (d)-(e) J-CNT-15 joint interfaces.....	138
5.7	XRD patterns of C/SiC-C/SiC joint interfaces.....	139
5.8	LSS and Rockwell hardness of C/SiC-C/SiC joints.....	141
5.9	SEM images of fracture surfaces of (a) J-CNT-0, (b) J-CNT-5, (c) J-CNT-10, and (d) J-CNT-15.....	142
5.10	Interface evolution model: (a)-(c) J-CNT-0, (d)-(f) J-CNT-5, (g)-(i) J-CNT-10, and (j)-(l) J-CNT-15.....	144

Chapter 6

6.1	DSC curves of various brazing fillers.....	158
6.2	Wettability study of (a) Mo-0, (b) Mo-4, (c) Mo-8, and (d) Mo-12 fillers on SiC at 1300°C.....	159
6.3	(a) SEM image, (b) line scans, and (c) EDS mapping of J-Mo-0.....	160
6.4	XRD pattern for the interface of SiC-SiC joints.....	162
6.5	(a) Ni-Si binary, and (b) Ni-Si-C ternary phase diagram at 1300°C.....	164
6.6	(a) SEM image, (b) line scans, and (c) EDS mapping of J-Mo-4.....	164
6.7	(a) Mo-C binary, and (b) Ni-Mo-C ternary phase diagram at 1300°C.....	165
6.8	(a) SEM image, (b) line scans, and (c) EDS mapping of J-Mo-8.....	166
6.9	(a) SEM image, (b) line scans, and (c) EDS mapping of J-Mo-12.....	167
6.10	LSS stress-strain graph of SiC-SiC joints.....	169
6.11	SEM-EDS analysis for fracture surface of (a, b) J-Mo-0; (c, d) J-Mo-4; (e, f) J-Mo-8; and (g, h) J-Mo-12.....	171
6.12	Conceptual interfacial microstructural evolution model: (a)-(c) J-Mo-0, (d)-(f) J-Mo-4, (g)-(i) J-Mo-8, and (j)-(l) J-Mo-12 joints.....	173
6.13	Gibbs free energy (ΔG) of possible reactions.....	174

List of Tables

Table No.	Table	Page No.
Chapter 1		
1.1	Energies of chemical bonds in different bonding types.....	8
1.2	Properties of high-performance M/s. Toray makes carbon fibres.....	11
1.3	Physical and mechanical properties of ceramics.....	15
Chapter 2		
2.1	Joining of C/SiC composites using Si/Polymer-based fillers.....	43
2.2	Joining of C/SiC composites using Ni-based filler.....	45
2.3	Joining of C/SiC composites using Mo-based filler.....	46
2.4	Joining of C/SiC composites using MAX phase-based filler.....	47
2.5	Joining of C/SiC composites using high-temperature fillers.....	51
2.6	Diffusion bonding of C/SiC to metals.....	53
2.7	Brazing of C/SiC to metals using low-temperature braze alloys.....	55
2.8	Brazing of C/SiC to metals using high-temperature braze alloys.....	58
2.9	Joining of SiC ceramics using preceramic polymer.....	61
2.10	Joining of SiC ceramics using no interlayer.....	62
2.11	Joining of SiC ceramics by diffusion bonding.....	62
2.12	Joining of SiC ceramics using Ti-based fillers.....	64
2.13	Joining of SiC ceramics using Ti-free fillers.....	67
2.14	Joining of SiC ceramics using metal-ceramic fillers.....	68
2.15	Joining of SiC ceramics using MAX phase fillers.....	70
Chapter 3		
3.1	Physical properties of some candidate elements.....	87
Chapter 4		
4.1	Physicochemical properties of the alloys.....	103
4.2	Process variables with their experimental design levels.....	104
4.3	CCD matrix with actual independent process variables and responses.....	105
4.4	Elemental composition and possible phases for the Ticusil-based C/SiC–C103 joint.....	108
4.5	Elemental composition and possible phases for the Cusil-based C/SiC–C103 joint.....	111
4.6	Analysis of variance (ANOVA) for LSS response surface quadratic model for Ticusil-based joint.....	117
4.7	Analysis of variance (ANOVA) for LSS response surface quadratic model for Cusil-based joint.....	118
4.8	Optimal process parameters and corresponding LSS for C/SiC–C103 joints.....	120
4.9	Literature reported shear strength of C/SiC- C103 (Nb) joints by brazing process	120
Chapter 5		
5.1	Details of the brazing filler formulations.....	131
5.2	Literature reported shear strength of C/SiC-C/SiC joints by brazing process.....	143

Chapter 6

6.1	Elemental composition and primary phases for all SiC-SiC joints.....	161
6.2	Literature reported shear strength of α -SiC ceramic joints by brazing process.....	172
6.3	Crystal structure parameters and unit cell volume of various phases.....	177

Nomenclature

W_a	Work of adhesion
γ_{lv}	liquid-vapour interfacial energy
(s,s)	Solid solution
γ_{sl}	solid-liquid interfacial energy
γ_{sv}	solid-vapour interfacial energy
\bar{d}_p	Average particle size
ΔT	Difference in room-to-reaction temperature
$\Delta\alpha$	Difference in CTE
C_0	Constant
CR	Cooling rate
d	Desirability
E	Activation energy of diffusion
E_c	Ceramic Young's modulus
E_m	Metal Young's modulus
E_{mp}	Linear strain hardening coefficient
P_c	Capillary pressure
r	Effective pore radius
R	Universal gas constant
S	Spreading coefficient
T	Temperature
t	time
T_m	Melting temperature
w	Width
w	Weighted factor
$\beta_i, \beta_{ii},$ and	regression coefficients
ΔG	Gibbs free energy
σ	Surface tension
σ_c	Residual stresses
σ_y	Metal yield strength

Greek symbols

α	Hexagonal
β	Cubic
θ	Angle, hexagonal
ε	Error, hexagonal
δ	Orthorhombic
ζ	Orthorhombic

Abbreviations

A4PB	Asymmetric 4-point bending
ABA	Active brazing alloy
ACC	Advanced carbon/carbon
ANOVA	Analysis of variance
BN	Boron nitride

CCD	Central composite design
CFRP	Carbon fibre-reinforced polymers
CMCs	Ceramic matrix composites
CNT	Carbon nanotube
CTE	Coefficient of thermal expansion
CVD	Chemical vapour deposition
CVI	Chemical vapour infiltration
DB	Diffusion bonding
DLO	Double lap offset
DN	Double-notch
DSC	Differential scanning calorimetry
EBSD	Electron backscatter diffraction
EDS	Energy dispersive spectrometer
ESA	European Space Agency
FCC	Face-centred cubic
FE-SEM	field emission scanning electron microscope
HCP	Hexagonal closed packing
HM	High modulus
HS	High strength
HT	High temperature
IPA	Isopropyl alcohol
IRZ	Interfacial reaction zone
LS	Low strength
LSS	Lap shear strength
LST	Low service temperature
MMC	Metallic matrix composites
MMS	Monomethylsilane
MTS	Methyl trichlorosilane
MWCNTs	Multiwall carbon nanotubes
NDT	Non-destructive test
PAN	Polyacrylonitrile
PCS	Polycarbosilane
PDC	Polymer derived ceramics
PIP	Polymer infiltration pyrolysis
PLS	Pressureless-sintered
PSZ	Polysilazane
PyC	Pyrolytic carbon
RB-SiC	Reaction bonded SiC
RLV	Reusable launch vehicles
RMI	Reactive melt infiltration
RSM	Response surface methodology
RT	Room temperature
SEM	Scanning electron microscope
SiCNT	Silicon carbide nanotube
SL	Single lap
SLO	Single lap offset
SPS	Spark plasma sintering
SPS-DB	Spark plasma sintering-diffusion bonding technique
SSTO	Single stage to orbit

TC	Torsion cylinder
THG	Torsion hourglass
TLPB	Transient liquid phase diffusion bonding
TPS	Thermal protection systems
TRS	Thermal residual stress
TS	Torsion square
TSTO	Two stage to orbit
TT	Torsion tube
UAB	Ultrasonic-assisted brazed
UTM	Universal testing machine
V-PMS	Polymethylsilane
XRD	X-Ray diffraction